



ON Semiconductor®

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# LV5212VH

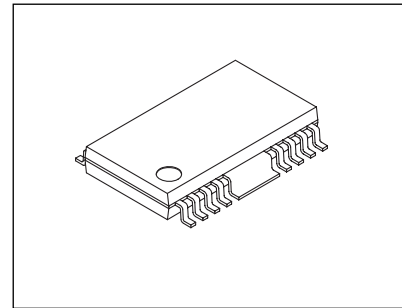
## Bi-CMOS IC 8ch LED Driver

### Overview

The LV5212VH is a semiconductor integrated circuit that incorporates a serial input and serial or parallel output 8-stage shift register that features a CMOS structure based on Bi-CMOS process technology. The LV5212VH also contains an n-channel CMOS construction high-withstand-voltage, large-current drive 8-stage parallel output driver.

### Function

- Serial input and serial or parallel output
- Enable input for output control
- Serial output enables cascade connection
- Low supply current (0.0μA typ. during standby)
- Serial input/output levels compatible with typical CMOS devices
- High-withstand-voltage LED driver with open drain output
  - High withstand voltage ( $V_{DS} < 50V$ )
  - High-current drive ( $I_O \text{ max} = 300mA$ )
- Operating temperature range  $T_a = -25$  to  $75^\circ C$



HSSOP16(275mil)

### Specifications

#### Absolute Maximum Ratings at $T_a = 25^\circ C$

Parameter	Symbol	Conditions	Ratings	Unit
Maximum supply voltage	$V_{CC \text{ max}}$	$SV_{CC}$	6	V
Output voltage	$V_O \text{ max}$	LEDO1 to LEDO8 off	50	V
Output current	$I_O \text{ max}$		300	mA
Allowable power dissipation	$P_d \text{ max}$	$T_a \leq 25^\circ C$ *	1000	mW
Operating temperature	$T_{opr}$		-25 to +75	$^\circ C$
Storage temperature	$T_{stg}$		-40 to +125	$^\circ C$

\* Specified board : 114.3mm × 76.1mm × 1.6mm, glass epoxy board.

\* The device must be used within the ranges warranted for its specifications so as to ensure its specified ratings (such as maximum ratings and operating condition ranges) are not exceeded even momentarily.

Use of the device in such a way that its ratings are exceeded may cause failures, damage and other problems.

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

### ORDERING INFORMATION

See detailed ordering and shipping information on page 10 of this data sheet.

# LV5212VH

## Recommended Operating Conditions at $T_a = 25^\circ\text{C}$

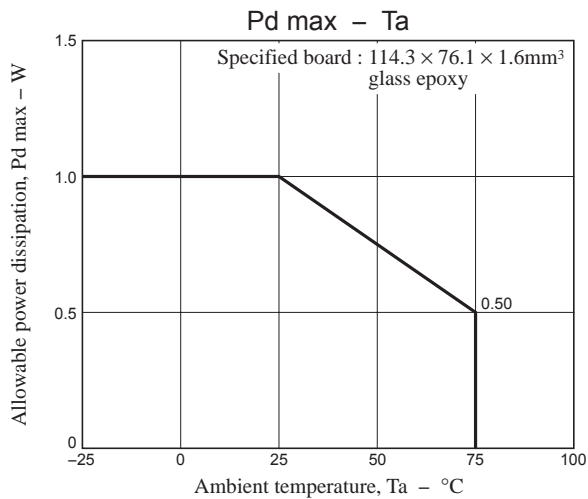
Parameter	Symbol	Conditions	Ratings	Unit
Recommended supply voltage	$V_{CC}$	$SV_{CC}$	5.0	V
Operating supply voltage range	$V_{CC\text{ op}}$	$SV_{CC}$	3.0 to 5.5	V
Output applied voltage	$V_O$		50	V
Output current	$I_O$	Duty = 45% to 55%	300	mA

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

## Electrical Characteristics at $T_a = 25^\circ\text{C}$ , $V_{CC} = 5\text{V}$

Parameter	Symbol	Conditions	Ratings			Unit
			min	typ	max	
Quiescent current drain	$I_{CC1}$	LEDO driver off (standby)		0	5	$\mu\text{A}$
LEDO output on resistance	$R_{on}$	$I_O = 100\text{mA}$		3		$\Omega$
OFF leak current	$I_{leak}$	$V_O = 50\text{V}$		0	10	$\mu\text{A}$
<b>Control circuit block</b>						
H level 1	$V_{INH1}$	Input H level	$V_{CC} \times 0.8$			V
L level 1	$V_{INL1}$	Input L level	0		$V_{CC} \times 0.2$	V
H level 2	$V_{OUTH1}$	SOUT $I_O = -1\text{mA}$	$V_{CC} - 0.3$			V
L level 2	$V_{OUTL1}$	SOUT $I_O = 1\text{mA}$	0		0.3	V

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.



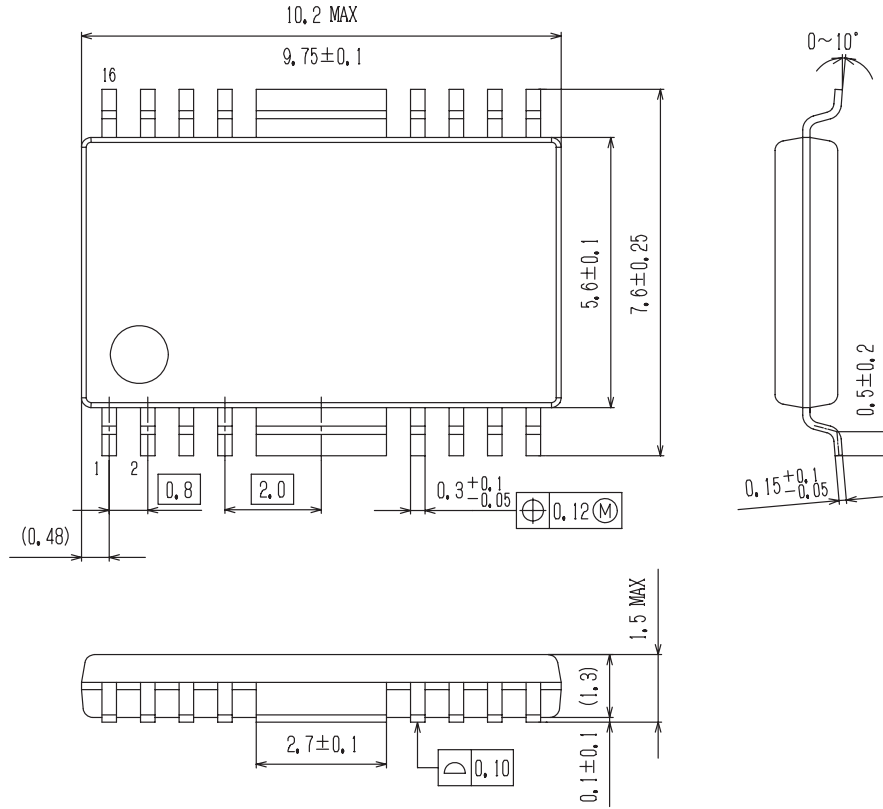
# LV5212VH

## Package Dimensions

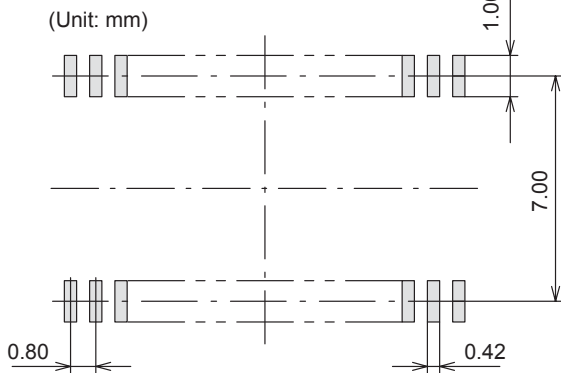
unit : mm

### HSSOP16 (275 mil)

CASE 943AF  
ISSUE A



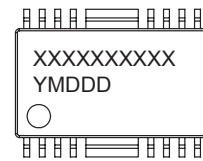
### SOLDERING FOOTPRINT\*



NOTE: The measurements are not to guarantee but for reference only.  
Land pattern design in Fin area to be altered in response to customers' individual application.

\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

### GENERIC MARKING DIAGRAM\*

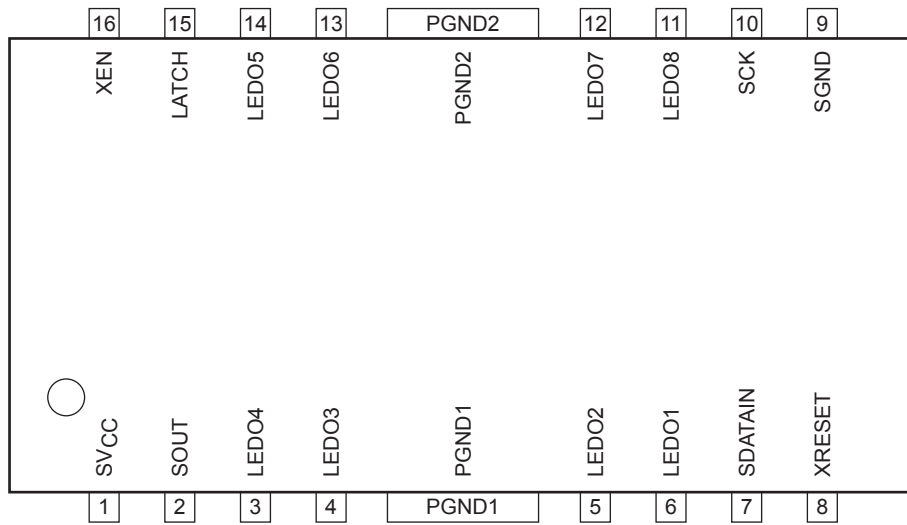


XXXXX = Specific Device Code  
Y = Year  
M = Month  
DDD = Additional Traceability Data

\*This information is generic. Please refer to device data sheet for actual part marking.  
Pb-Free indicator, "G" or microdot "•", may or may not be present.

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## Pin Assignment

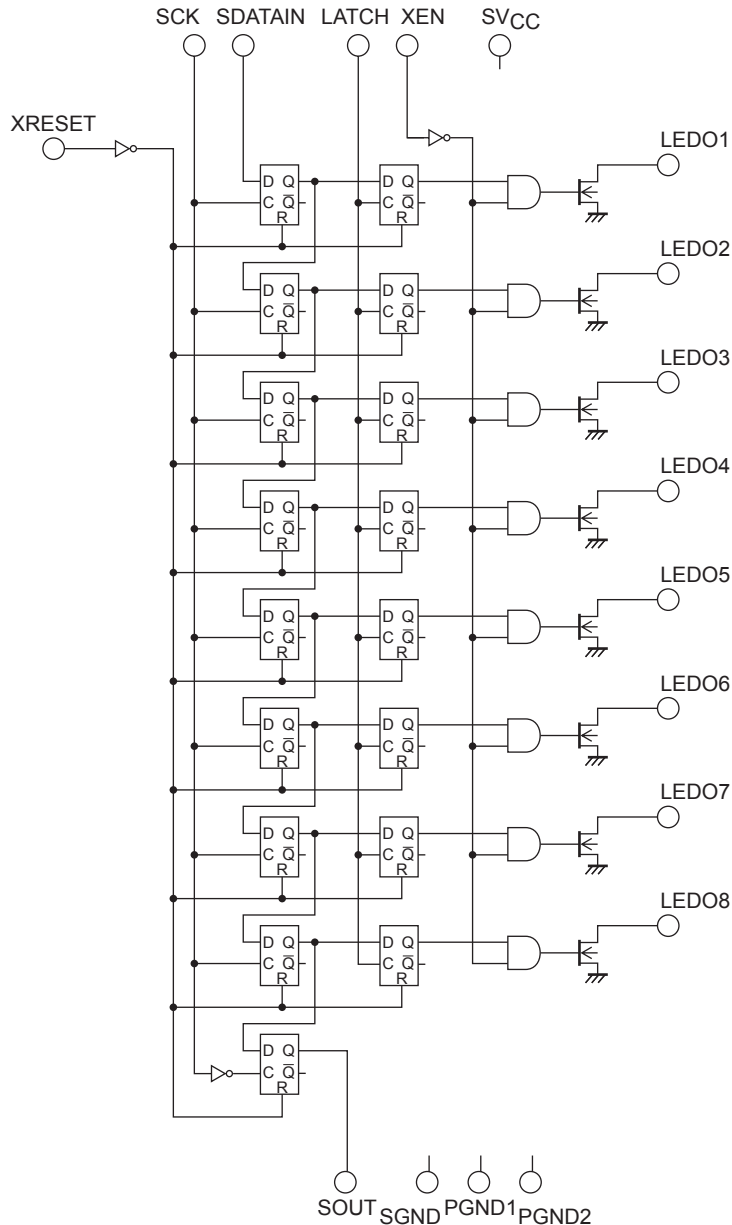


Top view

## Pin Descriptions

Pin No.	Pin name	I/O	Description
1	SVCC		Power supply
2	SOUT	O	shift register output (final-stage shift register)
3	LEDO4	O	LEDO4 Latch output (LEDO4 of shift register)
4	LEDO3	O	LEDO3 Latch output (LEDO3 of shift register)
5	LEDO2	O	LEDO2 Latch output (LEDO2 of shift register)
6	LEDO1	O	LEDO1 Latch output (LEDO1 of shift register)
7	SDATAIN	I	Serial input
8	XRESET	I	Reset input (shift register and latch)
9	SGND		GND
10	SCK	I	Clock input (for shift register)
11	LEDO8	O	LEDO8 Latch output (LEDO8 of shift register)
12	LEDO7	O	LEDO7 Latch output (LEDO7 of shift register)
13	LEDO6	O	LEDO6 Latch output (LEDO6 of shift register)
14	LEDO5	O	LEDO5 Latch output (LEDO5 of shift register)
15	LATCH	I	Latch input When the latch input is held low, the LED0 output status is retained. When a high-level is input, the LED0 outputs change when the status of the shift register changes.
16	XEN	I	Enable inputs (LEDO1 to LEDO8) When a high-level is input, all the LED0 outputs are turned off. When a low-level is input, the shift register data is output to LED0.
PGND1	PGND1		GND
PGND1	PGND2		GND

Block Diagram



Function

The LV5212VH consists of 1) an 8-stage D-type flip-flop and 2) an 8-stage D-type flip-flop connected to the output of 1). When data is supplied to the serial data input (SDATAIN) and the clock pulse is supplied to the clock input (SCK), the serial data input signal is input to the internal shift register and the data already in the shift register shifted sequentially when the clock changes from low to high.

The serial output (SOUT) is used to connect multiple LV5212VH to expand the number of bits and is connected to the SDATAIN of the next stage. (Cascade connection supported.)

For parallel output, when the output control enable input (XEN) is low, the latch input (LATCH) changes from low to high and the clock pulse input changes from low to high, the serial data input signal is output to LED01, and the output is shifted sequentially. For parallel outputs (LED2 to LED8), the signals whose polarities inverted from those of the serial data input (SDATAIN) are output.

When the EN input is high, outputs LED01 through LED01 all turn off.

When the reset input is low, outputs LED01 through LED8 and SOUT outputs all turn off. The power must be turned on after checking that the reset input is low.

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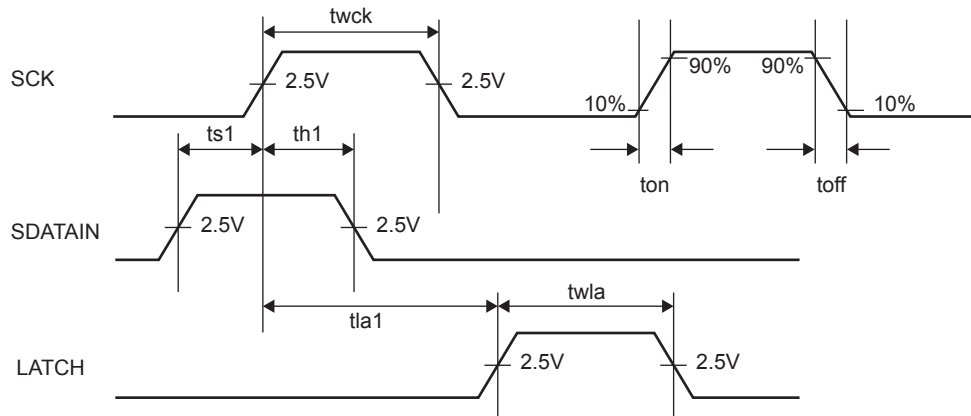
## Pin Functions

Pin No.	Pin Name	Pin function	Equivalent Circuit
7 10	SDATAIN SCK	Pull-down input	<p>The diagram shows a pull-down input circuit. A resistor is connected between the input pin and the signal ground (SGND). Two protection diodes are connected to the input pin: one pointing towards the supply voltage (SVCC) and another pointing towards the signal ground (SGND).</p>
8 15 16	XRESET LATCH XEN	Pull-up input	<p>The diagram shows a pull-up input circuit. A resistor is connected between the input pin and the supply voltage (SVCC). Two protection diodes are connected to the input pin: one pointing towards the supply voltage (SVCC) and another pointing towards the signal ground (SGND).</p>
2	SOUT	SOUT output	<p>The diagram shows a push-pull output driver stage. It consists of an NPN and a PNP transistor connected in a complementary configuration. The output pin (SOUT) is connected to the emitter of the PNP transistor. Protection diodes are connected from the output pin to the supply voltage (SVCC) and the signal ground (SGND).</p>
3 4 5 6 11 12 13 14	LEDO4 LEDO3 LEDO2 LEDO1 LEDO8 LEDO7 LEDO6 LEDO5	LEDO outputs LEDO1 to LEDO8	<p>The diagram shows a push-pull output driver stage for LEDs. It consists of an NPN and a PNP transistor connected in a complementary configuration. The output pin is connected to the emitter of the PNP transistor. Protection diodes are connected from the output pin to the supply voltage (SVCC) and the power ground (PGND).</p>

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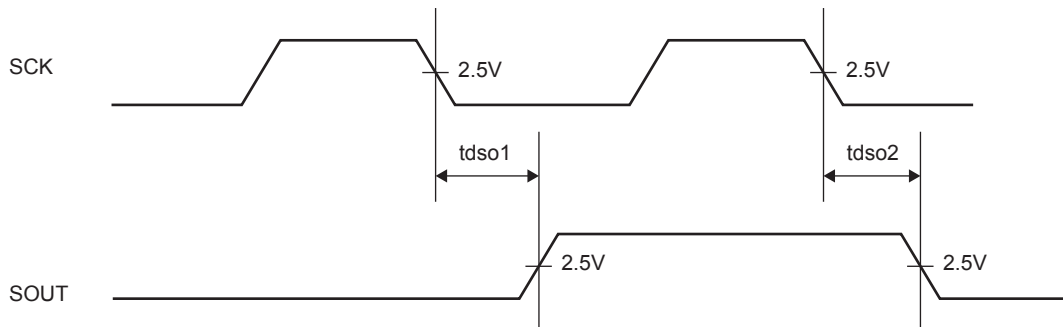
## Timing conditions

Parameter	symbol	Conditions	min	typ	max	unit
Clock frequency	fs1	SCK Duty = 50%			10	MHz
Clock pulse width	twck	SCK	50			ns
Latch pulse width	twla	LATCH	50			ns
Data set up time	ts1	SDATAIN setup time relative to the rise of SCK	25			ns
Data hold time	th1	SDATAIN data hold time relative to the rise of SCK	25			ns
Clock latch time	tla1		100			ns
Input conditions 1	ton	SCK and SDATAIN rise time			100	ns
Input conditions 2	toff	SCL and SDATAIN fall time			100	ns



## SOUT output timings

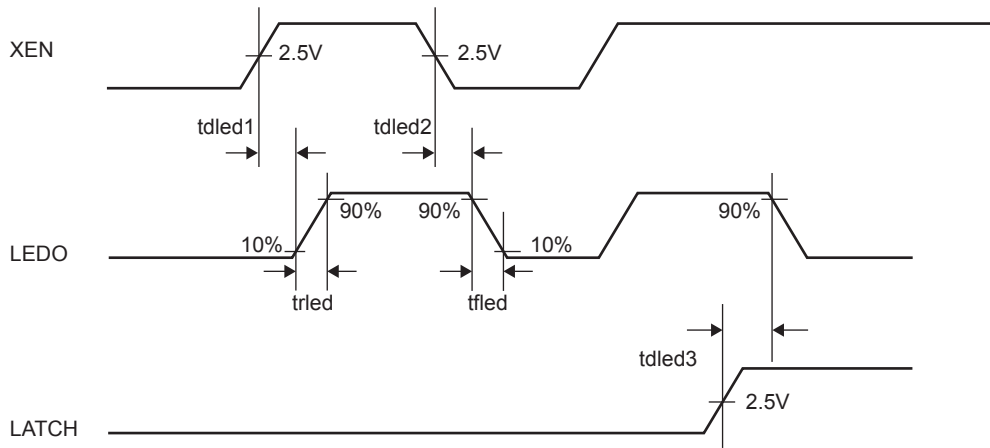
Parameter	symbol	Conditions	min	typ	max	unit
SOUT delay time 1	tdso1	The time from a SCK falling edge to SOUT rising edge			50	MHz
SOUT delay time 2	tdso2	The time from a SCK falling edge to SOUT falling edge			50	ns



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## LEDO output timings

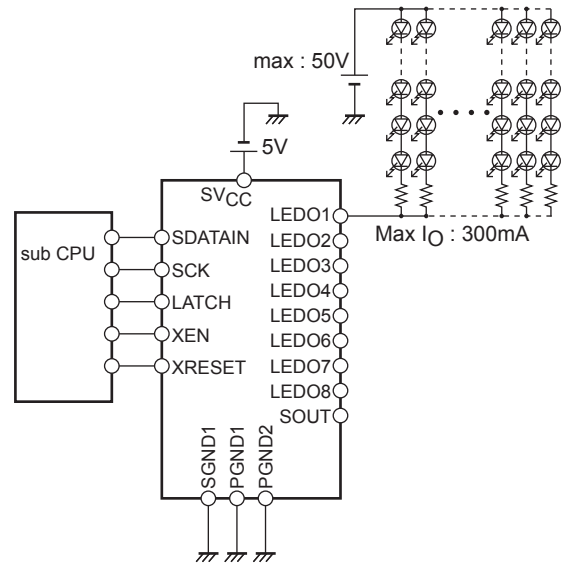
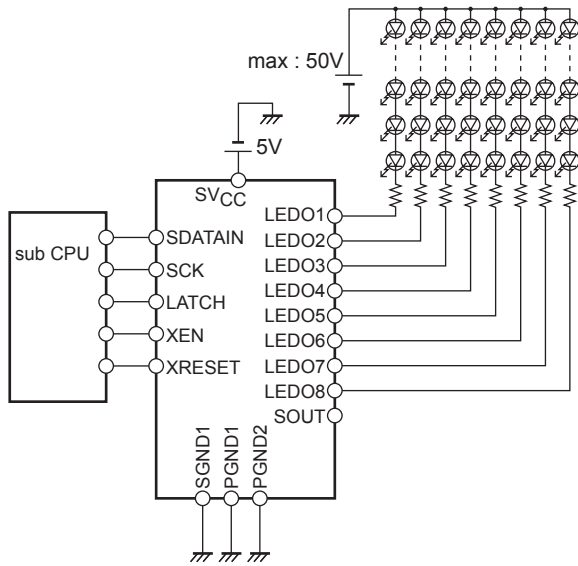
Parameter	symbol	Conditions	min	typ	max	unit
LEDO delay time 1	tdled1	The time from an XEN rising edge to LEDO rising edge CL = 30pF, I <sub>O</sub> = 100mA, V <sub>O</sub> = 30V		100		ns
LEDO delay time 2	tdled2	The time from an XEN falling edge to LEDO falling edge CL = 30pF, I <sub>O</sub> = 100mA, V <sub>O</sub> = 30V		100		ns
LEDO rise time	trled	LEDO rise time CL = 30pF, I <sub>O</sub> = 100mA, V <sub>O</sub> = 30V		200		ns
LEDO fall time	tfled	LEDO fall time CL = 30pF, I <sub>O</sub> = 100mA, V <sub>O</sub> = 30V		200		ns
LEDO delay time 3	tdled3	The time from a LATCH rising edge to LEDO falling edge CL = 30pF, I <sub>O</sub> = 100mA, V <sub>O</sub> = 30V		200		ns



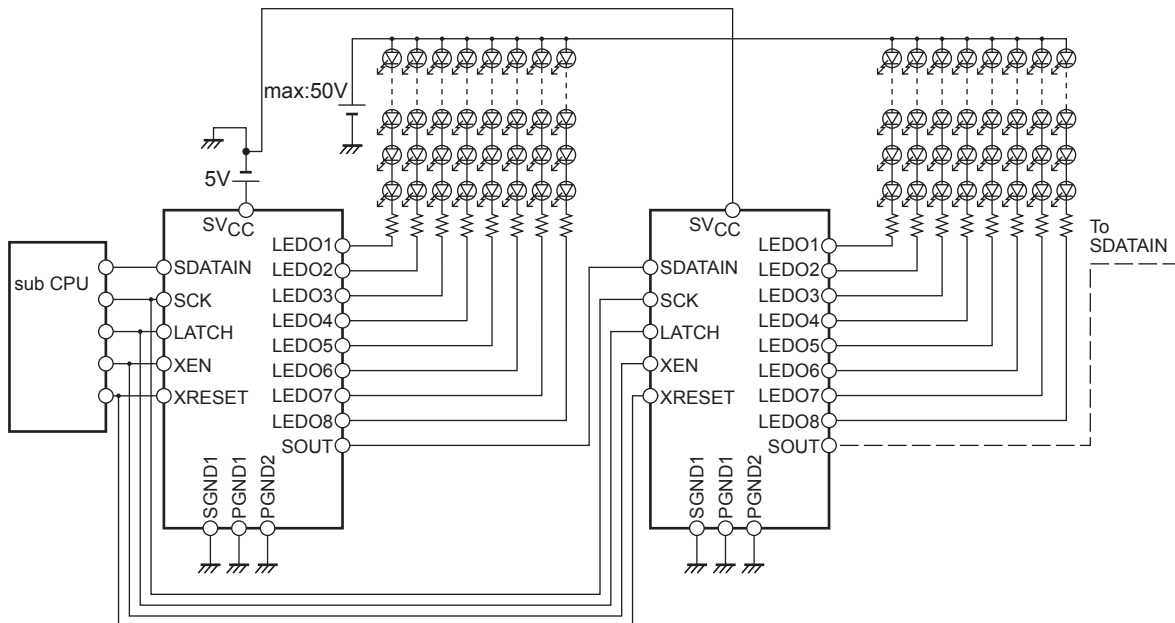


## Application Circuit Example

- When parallel output is used

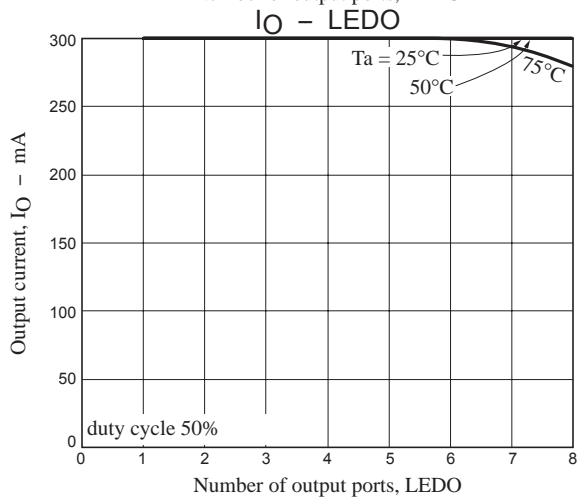
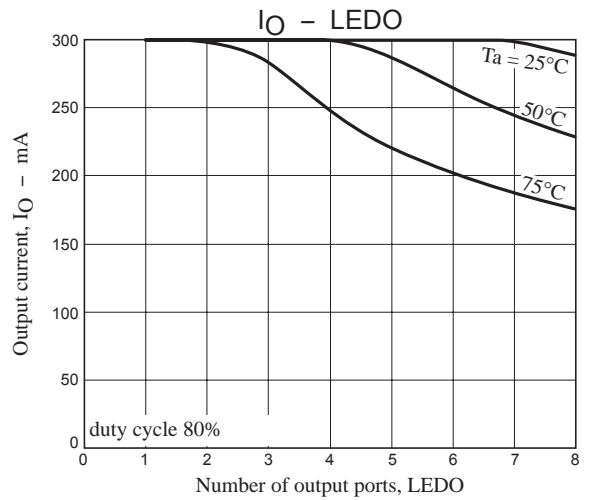
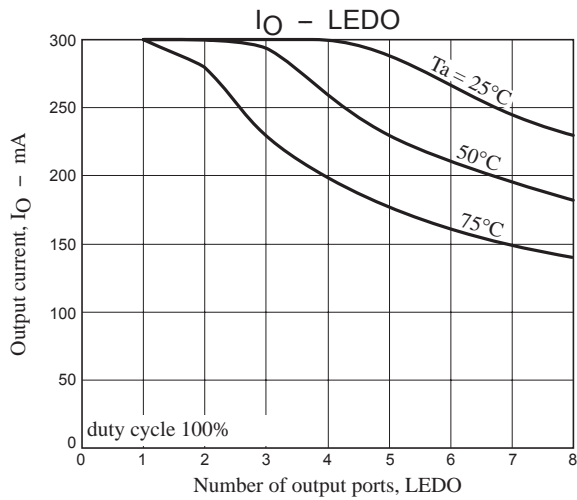


- When serial output is used (SOUT cascade connection)



# LV5212VH

## Allowable output current characteristics



## ORDERING INFORMATION

Device	Package	Shipping (Qty / Packing)
LV5212VH-MPB-H	HSSOP16 (275mil) (Pb-Free / Halogen Free)	48 / Fan-Fold
LV5212VH-TLM-H	HSSOP16 (275mil) (Pb-Free / Halogen Free)	1000 / Tape & Reel

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- Поставка более 17-ти миллионов наименований электронных компонентов;
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- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



#### Как с нами связаться

**Телефон:** 8 (812) 309 58 32 (многоканальный)

**Факс:** 8 (812) 320-02-42

**Электронная почта:** [org@eplast1.ru](mailto:org@eplast1.ru)

**Адрес:** 198099, г. Санкт-Петербург, ул. Калинина, дом 2, корпус 4, литера А.